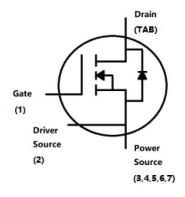




S2M0025120J 1200V SIC POWER MOSFET



Circuit Diagram



Description

S2M0025120J is single SiC Power MOSFET packaged in TO-263-7 case. The device is a high voltage n-channel enhancement mode MOSFET that has very low total conduction losses and very stable switching characteristics over temperature extremes. The S2M0025120J is ideal for energy sensitive, high frequency applications in challenging environments.

Features

- · Positive temperature characteristics, easy to parallel.
- Low on-resistance Typ. RDS(on) = 25m^Q .
- · Fast switching speed and low switching losses.
- · Very fast and robust intrinsic body diode.
- Process of non-bright Tin electroplatin

Applications

- EV Fast Charging Modules
- EV On Board Chargers
- Solar Inverters
- Online UPS/Industrial UPS
- SMPS (Switch Mode Power Supplies)
- DC-DC Converters
- ESS (Energy Storage Systems)

Maximum Ratings(T=25°C unless otherwise specified)

Characteristics	Symbol	Condition	Max.	Units
Drain Source Voltage	V _{DSS}	V _{GS} = 0V, I _{DS} = 100uA, T _j = 25°C	1200	V
Gate Source Voltage	V _{GSS}	T _j = 25°C, Absolute maximum values, AC (f>1Hz)	-10 to +25	V
Gate Source Voltage	V_{GSOP}	T _j = 25°C Recommended Operational Values	-5 to +20	V
Continuous Drain Current	I _D	V _{GS} = 20V, T _j = 25°C	70	А
	I _D	V _{GS} = 20V, T _j = 100°C	50	Α
Pulsed Drain Current	I _{D,pulse}	Pulse width t _P limited by T _{jmax}	250	А
Power Dissipation	P _D	T _C =25°C, T _J = 175 °C	311	W
Solder Temperature	TL	1.6mm (0.063") from case for 10s	260	°C

- China Germany Korea Singapore United States
 - http://www.smc-diodes.com sales@ smc-diodes.com •





Electrical Characteristics(T=25°C unless otherwise specified)

Characteristics	Symbol	Condition	Min.	Тур.	Max.	Units	
Drain Source Breakdown Voltage	$V_{(BR)DSS}$	V _{GS} = 0V, I _D = 100uA 1200				V	
Gate Threshold Voltage		$V_{DS} = V_{GS}$, $I_D = 15$ mA	1.8	2.6	4	V	
	$V_{\text{GS(th)}}$	V _{DS} = V _{GS} , I _D = 15mA, T _J = 175 °C		1.8		V	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 1200V, V _{GS} = 0V		2	100	uA	
Gate Source Leakage Current	I _{GSS}	V _{GS} = 20V, V _{DS} = 0V	V _{GS} = 20V, V _{DS} = 0V		250	nA	
Drain Source On-State	Б	V _{GS} = 20V, I _D = 50A		25	34	mΩ	
Resistance	R _{DS(on)}	V _{GS} = 20V, I _D = 50A, T _J = 175 °C		41		mΩ	
	•	V _{DS} = 20 V, I _{DS} = 50 A		16		S	
Transconductance	gfs	V _{DS} = 20 V, I _{DS} = 50 A, T _J = 175 °C		18		S	
Input Capacitance	C _{ISS}	$V_{GS} = 0V$,		4150			
Output Capacitance	Coss	V _{DS} = 1000V		201		pF	
Reverse Transfer Capacitance	C _{RSS}	V _{AC} = 25mV		5			
Coss Stored Energy	Eoss	f = 500KHz		81.93		uJ	
Turn-On Switching Energy	Eon	V _{DS} = 800V, V _{GS} = -5/20V		0.74		1	
Turn-Off Switching Energy	Eoff	$I_D = 50A, R_{G(ext)} = 2.5\Omega$		0.15		mJ	
Turn-On Delay Time	$t_{\text{d(on)}}$	V _{DS} = 800V, V _{GS} = -5/20V		29			
Rise Time	t _r	$I_D = 50A, R_{G(ext)} = 2.5\Omega$		15			
Turn-Off Delay Time	$t_{d(off)}$			37		ns	
Fall Time	t_{f}			12			
Internal Gate Resistance	$R_{G(int)}$	f = 1MHz, VAC = 25 mV 2.8		2.8		Ω	
Gate to Source Charge	Q_gs	V _{DS} = 800V, V _{GS} = -5/20V		88			
Gate to Drain Charge	Q_{gd}	I _D = 50A		17		nC	
Total Gate Charge Q _g				177			

[•] China - Germany - Korea - Singapore - United States • • http://www.smc-diodes.com - sales@ smc-diodes.com •





Reverse Diode Characteristics:

Characteristics	Symbol	Condition	Тур.	Max.	Units
Diode Forward Voltage	V _{SD}	V _{GS} = -5V, I _{SD} = 25A	4.3		V
		V _{GS} = -5V, I _{SD} = 25A, T _J = 175°C	3.9		V
Continuous Diode Forward Current	Is	V _{GS} = -5V, T _C = 25°C		44	Α
Reverse Recovery Time	t _{rr}	V _{GS} = -5V, I _{SD} = 50A, T _J = 25°C	131		ns
Reverse Recovery Charge	Q _{rr}	V _R = 800V	330		nC
Peak Reverse Recovery Current	I _{mm}	dif/dt= 1057A/µs	6.3		Α

Thermal-Mechanical Specifications:

Characteristics	Symbol	Condition	Specification	Units
Junction Temperature	TJ	-	-55 to +175	°C
Storage Temperature	T _{stg}	-	-55 to +175	°C
Typical Thermal Resistance Junction to Case	Rejc	DC operation	0.48	°C/W
Typical Thermal Resistance Junction to Ambient	$R_{ heta JA}$		60	°C/W

Ordering Information:

Device	Package	Shipping
S2M0025120J	TO-263-7	800pcs/reel

Marking Diagram



Where XXXXX is YYWWL

 $\begin{array}{ll} \text{S2M} & = \text{Device Type} \\ \text{0025} & = R_{DS}(\text{on}) \end{array}$

120 = Reverse Voltage (1200V)

J = Package SSG = SSG YY = Year WW = Week L = Lot Number

Cautions: Molding resin

Epoxy resin UL:94V-0

- China Germany Korea Singapore United States
 - http://www.smc-diodes.com sales@ smc-diodes.com •





Ratings and Characteristics Curves

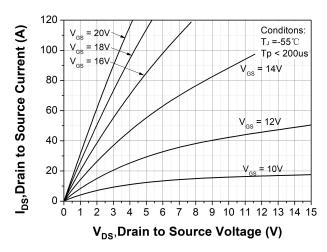


Figure 1. Output Characteristics T_J = -55 °C

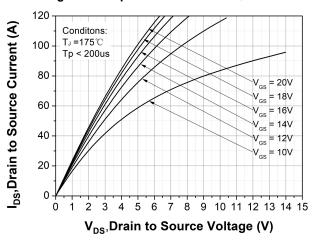


Figure 3. Output Characteristics T_J = 175°C Conditions:

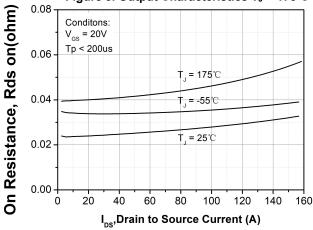


Figure 5. On-Resistance vs. Drain Current For Various Temperatures

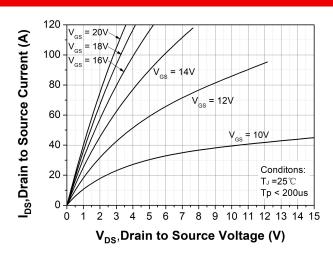


Figure 2. Output Characteristics T_J = 25 °C

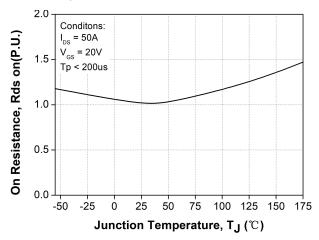


Figure 4. Normalized On-Resistance vs. Temperature

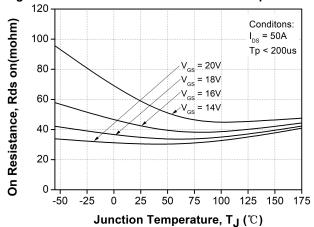


Figure 6. On-Resistance vs. Temperature For Various Gate Voltage

- China Germany Korea Singapore United States •
- http://www.smc-diodes.com sales@ smc-diodes.com •



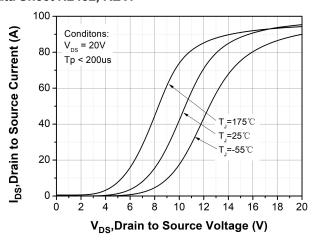


Figure 7. Transfer Characteristic for Various Junction Temperatures

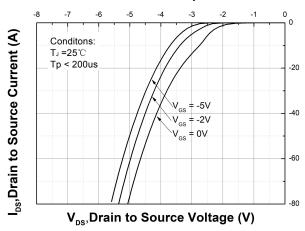


Figure 9. Body Diode Characteristic at T_J = 25 °C

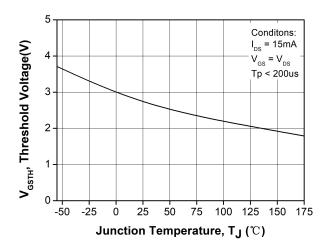


Figure 11. Threshold Voltage vs. Temperature

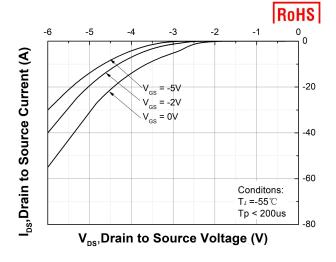


Figure 8. Body Diode Characteristic at T_J = -55 °C

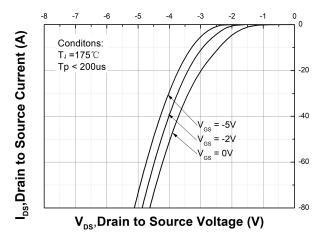


Figure 10. Body Diode Characteristic at T_J = 175 °C

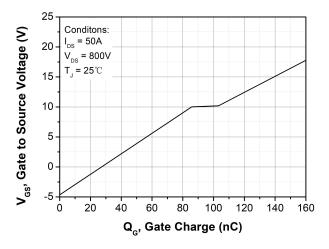
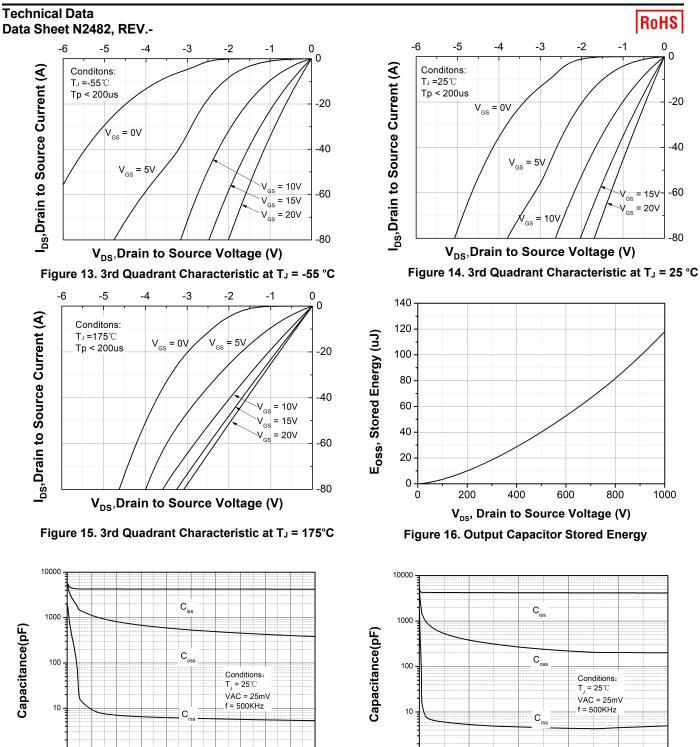


Figure 12. Gate Charge Characteristic

- China Germany Korea Singapore United States
 - http://www.smc-diodes.com sales@ smc-diodes.com •





• China - Germany - Korea - Singapore - United States •

400

Figure 18. Capacitances vs. Drain-Source

Voltage (0 - 1000V)

600

V_{DS}, Drain to Source Voltage (V)

1000

180

100 120 140

V_{DS}, Drain to Source Voltage (V)

Figure 17. Capacitances vs. Drain-Source

Voltage (0 - 200V)

http://www.smc-diodes.com - sales@ smc-diodes.com •



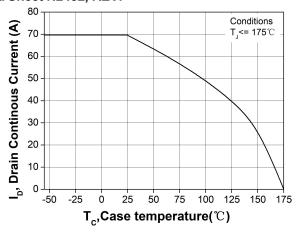


Figure 19. Continuous Drain Current Derating vs.
Case Temperature

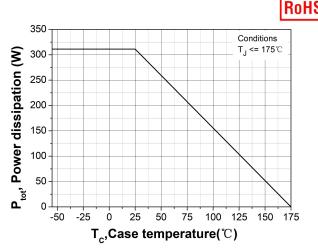


Figure 20. Maximum Power Dissipation Derating vs. Case Temperature

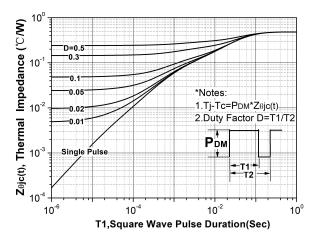


Figure 21. Transient Thermal Impedance (Junction - Case)

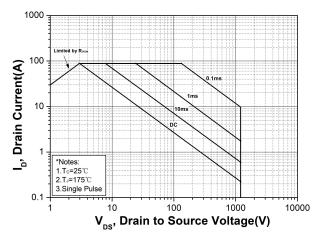


Figure 22. Safe Operating Area

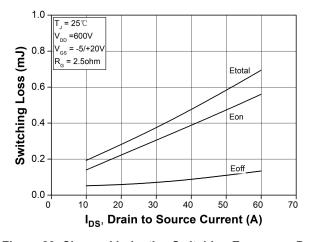


Figure 23. Clamped Inductive Switching Energy vs. Drain Current (V_{DD} = 600V)

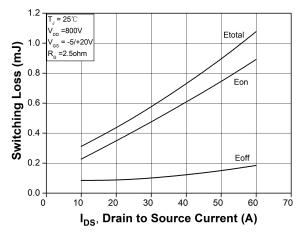


Figure 24. Clamped Inductive Switching Energy vs. Drain Current (V_{DD} = 800V)

- China Germany Korea Singapore United States
 - http://www.smc-diodes.com sales@ smc-diodes.com •





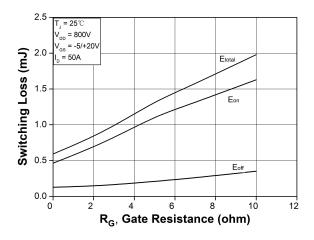


Figure 25. Clamped Inductive Switching Energy vs. R_{G(ext)}

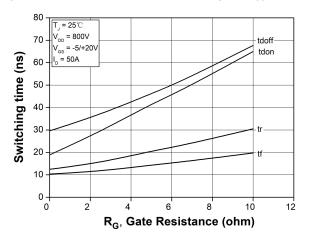


Figure 27. Switching Times vs. R_{G(ext)}

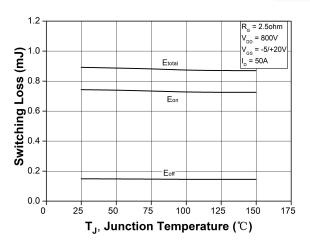


Figure 26. Clamped Inductive Switching Energy vs.
Temperature

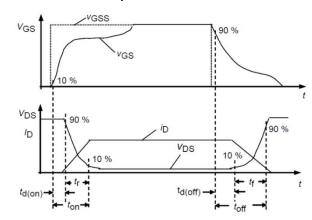
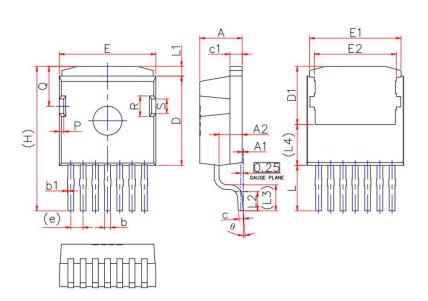


Figure 28. Switching Times Definition





Mechanical Dimensions TO-263-7



SYMBOL	Millimeters					
STIVIBUL	TYP.	MAX.	MIN			
Α	4.3	4.4	4.5			
A1	0	0.1	0.2			
A2	2.3	2.4	2.5			
b	0.5	0.6	0.7			
b1	0	0.075	0.15			
С	0.4	0.5	0.6			
c1	1.17	1.27	1.37			
D	9.05	9.25	9.45			
D1	5.9	6	6.1			
E	9.8	10	10.2			
E1	9.36	9.46	9.56			
E2	8.4	8.5	8.6			
е	1.270 REF					
Н	15.000 REF					
L	4.2 4.7		5.2			
L1	0.7	0.7 1				
L2	1.7 2		2.3			
L3	2.700 REF					
L4	4.250 REF					
Р	0.35	0.45	0.55			
Q	4.02	4.12	4.22			
R	2.03	2.13	2.23			
S	1.4	1.5	1.6			
θ	4°	8°	0°			

[•] http://www.smc-diodes.com - sales@ smc-diodes.com •

S2M0025120J



Technical Data Data Sheet N2482, REV.-



DISCLAIMER:

- 1- The information given herein, including the specifications and dimensions, is subject to change without prior notice to improve product characteristics. Before ordering, purchasers are advised to contact the SMC Diode Solutions sales department for the latest version of the datasheet(s).
- 2- In cases where extremely high reliability is required (such as use in nuclear power control, aerospace and aviation, traffic equipment, medical equipment, and safety equipment), safety should be ensured by using semiconductor devices that feature assured safety or by means of users' fail-safe precautions or other arrangement.
- 3- In no event shall SMC Diode Solutions be liable for any damages that may result from an accident or any other cause during operation of the user's units according to the datasheet(s). SMC Diode Solution assumes no responsibility for any intellectual property claims or any other problems that may result from applications of information, products or circuits described in the datasheets.
- 4- In no event shall SMC Diode Solutions be liable for any failure in a semiconductor device or any secondary damage resulting from use at a value exceeding the absolute maximum rating.
- 5- No license is granted by the datasheet(s) under any patents or other rights of any third party or SMC Diode Solutions.
- 6- The datasheet(s) may not be reproduced or duplicated, in any form, in whole or part, without the expressed written permission of SMC Diode Solutions.
- 7- The products (technologies) described in the datasheet(s) are not to be provided to any party whose purpose in their application will hinder maintenance of international peace and safety nor are they to be applied to that purpose by their direct purchasers or any third party. When exporting these products (technologies), the necessary procedures are to be taken in accordance with related laws and regulations..

X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for MOSFET category:

Click to view products by SMC Diode manufacturer:

Other Similar products are found below:

IRFD120 JANTX2N5237 BUK455-60A/B MIC4420CM-TR VN1206L NDP4060 SI4482DY IPS70R2K0CEAKMA1 SQD23N06-31L-GE3
TK16J60W,S1VQ(O 2SK2614(TE16L1,Q) DMN1017UCP3-7 DMN1053UCP4-7 SQJ469EP-T1-GE3 NTE2384 DMC2700UDMQ-7
DMN2080UCB4-7 DMN61D9UWQ-13 US6M2GTR DMN31D5UDJ-7 DMP22D4UFO-7B DMN1006UCA6-7 DMN16M9UCA6-7
STF5N65M6 IRF40H233XTMA1 STU5N65M6 DMN6022SSD-13 DMN13M9UCA6-7 DMTH10H4M6SPS-13 DMN2990UFB-7B
IPB80P04P405ATMA2 2N7002W-G MCAC30N06Y-TP MCQ7328-TP BXP7N65D BXP4N65F AOL1454G WMJ80N60C4 BXP2N20L
BXP2N65D BXT1150N10J BXT1700P06M TSM60NB380CP ROG RQ7L055BGTCR DMNH15H110SK3-13 SLF10N65ABV2
BSO203SP BSO211P IPA60R230P6 IPA60R460CE